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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. MATSUURA, et al.

Application No.: 10/519,713

Filed: December 30, 2004

For: ADHESIVE FILM FOR SEMICONDUCTOR USE, METAL

SHEET LAMINATED WITH ADHESIVE FIL, WIRING CIRCUIT LAMINATED WITH ADHESIVE FILM, AND SEMICONDUCTOR

Group: 2823

Examiner: Julio J. Maldonado

Confirm. No.: 7508

<u>AMENDMENT</u>

Mail Stop: Amendment Commissioner for Patents P.O. Box 1450

Alexandria, Virginia 22313-1450

February 16, 2007

Sir:

In response to the Office Action mailed November 16, 2006, please amend the above-identified application as listed in the following, and as set forth on the following pages:

Amendments to the Claims; and

Remarks are included following the amendments.

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